## Product data sheet Characteristics

# BMEH582040C

# redundant HSBY processor module M580 -Level 2 - Remote Coated



## Main

Range of product	Modicon M580
Product or component type	Redundant processor module
Impregnation material	Conformal coated
Supply	Internal power supply via rack

## Complementary

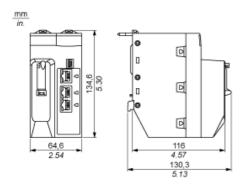
Number of racks	1	
Application specific I/O	Accurate time stamping Counter Serial link Motion control HART SSI encoder	
Checks	Process control	
Control channels	Programmable loops	
Integrated connection type	1 Ethernet TCP/IP service port 2 Ethernet TCP/IP device network USB type mini B 1 Ethernet HSBY port	
Number of remote I/O station	8 - 2 rack(s) per X80 remote drop	
Number of distributed equipment	64	
Communication module processor	2 Ethernet communication module 8 AS-Interface module	
Communication service	DIO scanner RIO scanner	
Memory description	Expandable flash 4 GB data storage Integrated RAM 10 kB system memory Integrated RAM 8 MB program Integrated RAM 768 kB data	
Application structure	1 cyclic/periodic master task 1 periodic fast task	
Number of instructions per ms	7.5 Kinst/ms 65 % Boolean + 35 % fixed arithmetic 10 Kinst/ms 100 % Boolean	
Current consumption	270 mA 24 V DC	
MTBF reliability	600000 H	
Marking	CE	

Status LED	1 LED green processor running (RUN)		
Status LED	1 LED green processor running (RON) 1 LED red processor or system fault (ERR)		
	1 LED red I/O module fault (I/O)		
	1 LED green download in progress (DL)		
	1 LED red memory card or CPU flash fault (BACKUP) 1 LED green/red ETH MS (Ethernet port configuration status) 1 LED green/red Eth NS (Ethernet network status) 1 LED green peer processor running (REMOTE RUN) 1 LED green processor ID set to A (A) 1 LED green processor ID set to B (B) 1 LED green processor acting as Primary (PRIM) 1 LED green processor acting as Standby (STBY) 1 LED green I/O values overrided by user (FORCED IO)		
		1 LED green Hot standby link status (Hsby Diag)	
		Product weight	0.849 kg
		Environment  Ambient air temperature for operation	-2560 °C
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		Ambient air temperature for storage	-4085 °C
		Operating altitude	02000 m
	Relative humidity	595 %	
IP degree of protection	IP20		
Standards	CSA C22.2 No 142		
	EN/IEC 61131-2		
	UL 508		
	LWD 2006/95/EC EMC 2004/108/EC		
	CSA C22.2 No 213 Class I Division 2		
	EN/IEC 60079-0		
	EN/IEC 60079-31		
	EN/IEC 60079-15		
Product certifications	GOST		
	RCM		
	WEEE directive 2002/96/EC		
	Merchant Navy EAC		
	REACH directive 1907/2006/EC		
	RoHS directive 1907/2000/EC		
	ATEX II 3 Gas & Dust zone 2/22		

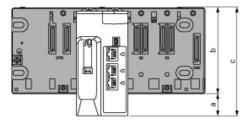
# Product data sheet Dimensions Drawings

## BMEH582040C

## **CPU MODULE ONLY**

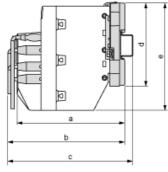


#### Modules Mounted on Racks



- a: additional space below the rack to accommodate the height of the CPU. For an X Bus rack, the value is 30.9 mm (1.217 in.); for an Ethernet rack, the value is 29.49 mm (1.161 in.).
- b: the height of the rack. For an X Bus rack, the height is 103.7 mm (4.083 in.); for an Ethernet rack, the height is 105.11 mm (4.138 in.).
- c: the height of the main local rack, 134.6 mm (5.299 in.)

## Modules and Cables Mounted in an Enclosure



- a: enclosure depth: 135 mm (5.315 in.)
- b: wiring + module depth: > 146 mm (5.748 in.)
- c: wiring + module + DIN rail depth: > 156 mm (6.142 in.)
- d: rack height: for an X Bus rack 103.7 mm (4.083 in.); for an Ethernet rack, 105.11 mm (4.138 in.)
- e: module height: 134.6 mm (5.299 in.)